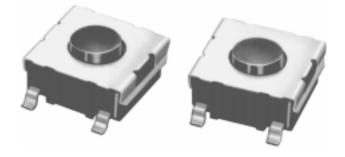


Mechanical Key Switch (SMD)

B3FS

Surface-mounting Switches Ideal for High-density Mounting

- Tape packing style also available
- Allows reflow soldering
- Incorporates a snap-action contact mechanism that ensures sharp switching operations



Ordering Information

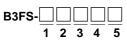


			Operating force (OF)	Part Number	
Туре	Plunger	Switch height x pitch		Bag (See Note 1.)	Embossed tape (See Note 2.)
Standard	Flat	6 x 6 mm	General-purpose: 100 gf	B3FS-1000	B3FS-1000P
			High-force: 150 gf	B3FS-1002	B3FS-1002P

Note: 1. Orders must be made in units of 100 pieces.

2. Orders must be made in units of 3,000 pieces. For the packing style, refer to Key Switch Packing on page 4.

■ PART NUMBER LEGEND



1. Appearance 1: 6 mm x 6 mm 2. Ground Terminal 0: None **3. Height** 0: 3.1 mm **4. Operating Force (OF)** 0: 100 gf 2: 150 gf

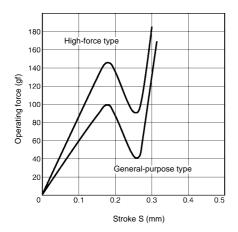
5. Shipment Package ---: Bag P: Embossed tape

- B3FS

Characteristics

Switching capacity		50 mA, 24 VDC (resistive load)	
Insulation voltage		30 VDC	
Contact configuration		SPST-NO	
Contact material		Silver plating	
Contact resistance		100 m Ω max. (initial value) (rated: 1 mA, 5 VDC)	
Insulation resistance		100 MΩ min. (at 100 VDC)	
Dielectric strength		250 VAC, 50/60 Hz for 1 min	
Bounce time		5 ms max.	
Vibration resistance		Malfunction: 10 to 55 Hz, 1.5-mm double amplitude	
Shock resistance		Destruction: 1,000 m/s ² min. {approx. 100G min.} Malfunction: 100 m/s ² min. {approx. 10G min.}	
Life expectancy	General-purpose type	1,000,000 operations min.	
	High-force type	300,000 operations min.	
Ambient temperature	Operating	-40°C to 85°C (-40°F to 185°F) with no icing	
Ambient humidity	Operating	35% to 85%	
Weight		Approx. 0.2 g	

■ CHARACTERISTIC DATA



OPERATING CHARACTERISTICS

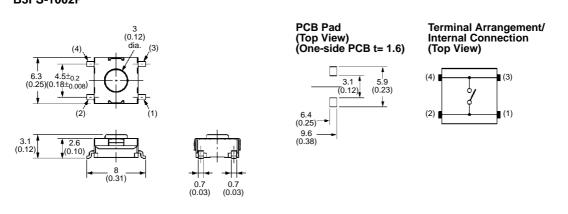
	B3FS-1000 Series		
	General-purpose	High-force	
Operating force (OF) max.	100±30 gf	150±50 gf	
Releasing force (RF) min.	20 gf	50 gf	
Pretravel (PT)	0.25 ^{+0.2} _{-0.1} mm		

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B3FS

Dimensions

Unit: mm (inch) B3FS-1000 B3FS-1002 B3FS-1000P B3FS-1002P



Precautions

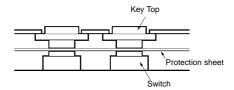
OPERATION

Do not repeatedly operate the Switch with high force, apply additional force to the plunger once it has stopped moving, or operate the Switch with excessive force, otherwise the disc spring of the Switch may deform and the Switch may malfunction.

Be sure to set the Switch so that the plunger will be pressed straight. A decrease in the life of the Switch may result if the plunger is pressed off-center or from an acute angle.



The Switch is not of enclosed construction. Be sure to protect the Switch with an appropriate sheet when using the Switch in locations with excessive dust.



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SOLDERING

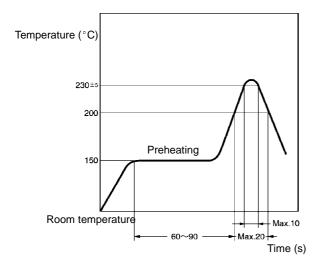
B3FS

Do not apply flow soldering, otherwise fragments of solder and flux may have a bad influence on the operation of the pushbutton.

Apply reflow soldering according to the optimum heating curve shown below. Reflow soldering equipment may have a high peak value. Be sure to conduct a test before use.

Soldering may be repeated only once at a minimum interval of five minutes if the Switch is not soldered properly.

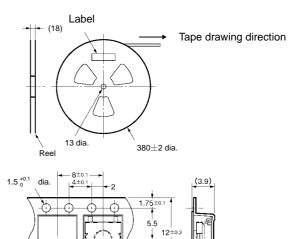
No flux can be wiped or cleaned after soldering the Switch because the cleaning solvent will penetrate into the interior of the Switch together with the flux and dust on the PCB. As a result, the Switch may malfunction.



Note: The above curve is given on condition that the thickness of the PCB is 1.6 mm.

KEY SWITCH PACKING

Key Switches are packed on tape as shown below.



Tape drawing direction

Standard	Conform to EIAJ standards	
Package	3,000 Switches	
Heat resistance	50°C for 24 hours (not be deformed)	

NOTE: DIMENSIONS SHOWN ARE IN MILLIMETERS. To convert millimeters to inches divide by 25.4.



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Cat. No. A113-E3-1

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